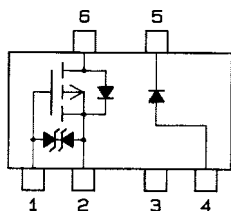


SANYO**FX854**MOSFET:P-Channel Silicon MOSFET
SBD:Schottky Barrier Diode**DC-DC Converter Applications****Features**

- Composite type composed of a low ON-resistance P-channel MOSFET for ultrahigh-speed switching and low-voltage driving and a fast-recovery, low forward-voltage Schottky barrier diode. Facilitates high-density mounting.
- The FX854 is formed with 2 chips, one being equivalent to the 2SJ190 and the other the SB05-05P, placed in one package.

Electrical Connection

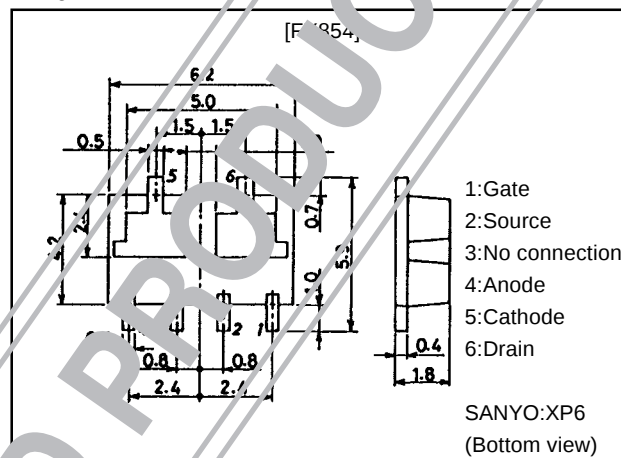
- 1:Gate
2:Source
3:No connection
4:Anode
5:Cathode
6:Drain

(Top view)

Package Dimensions

unit:mm

2119

**Specifications**Absolute Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
[MOSFET]				
Drain-to-Source Voltage	V_{DS}		-60	V
Gate-to-Source Voltage	V_{GS}		± 15	V
Drain Current (DC)	I_D		-1	A
Drain Current (Pulse)	I_{DP}	$PW \leq 10\mu s$, duty cycle $\leq 1\%$	-4	A
Allowable Power Dissipation	P_D	$T_c = 25^\circ\text{C}$	6	W
	P_D	Mounted on ceramic board (750mm ² ×0.8mm)	1.5	W
Channel Temperature	T_{CH}		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^\circ\text{C}$
[SBD]				
Repetitive Peak Reverse Voltage	V_{RRM}		50	V
Non-repetitive Peak Reverse Surge Voltage	V_{RSM}		55	V
Average Rectified Current	I_O		500	mA
Surge Forward Current	I_{FSM}	50Hz sine wave, 1cycle	5	A
Junction Temperature	T_j		-55 to +125	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +125	$^\circ\text{C}$

• Marking:854

Continued on next page.

SANYO Electric Co.,Ltd. Semiconductor Business Headquarters

TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110-8534 JAPAN

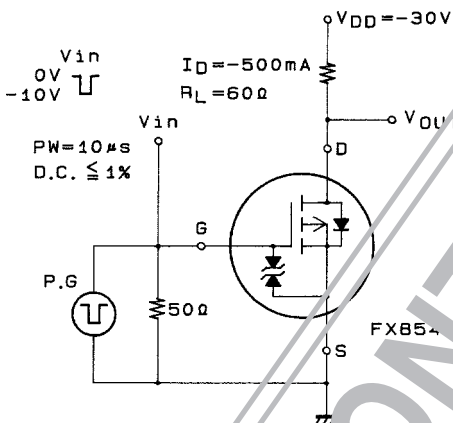
52098HA (KT)/71095TS (KOTO) TA-0116 No.4894-1/4

Continued from preceding page.

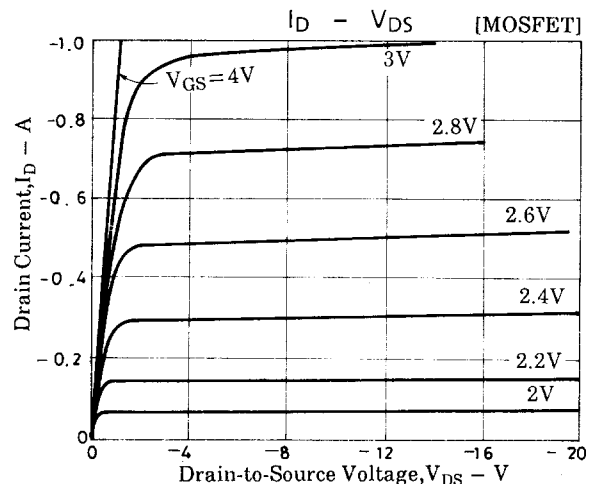
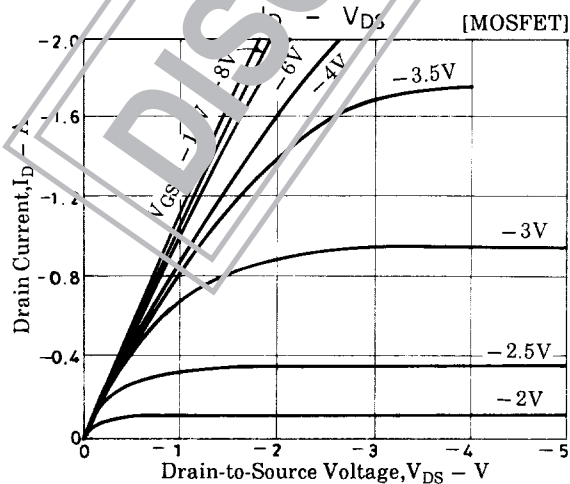
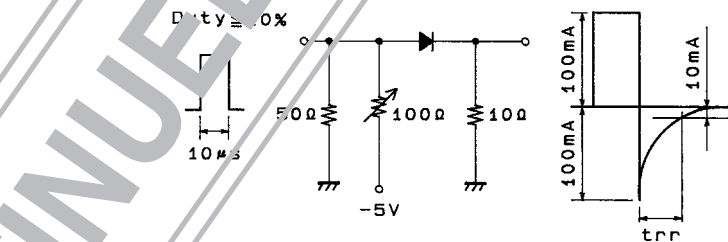
Electrical Characteristics at $T_a = 25^\circ\text{C}$

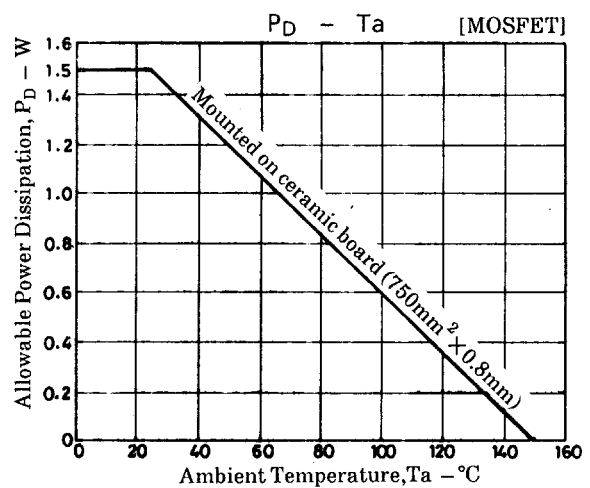
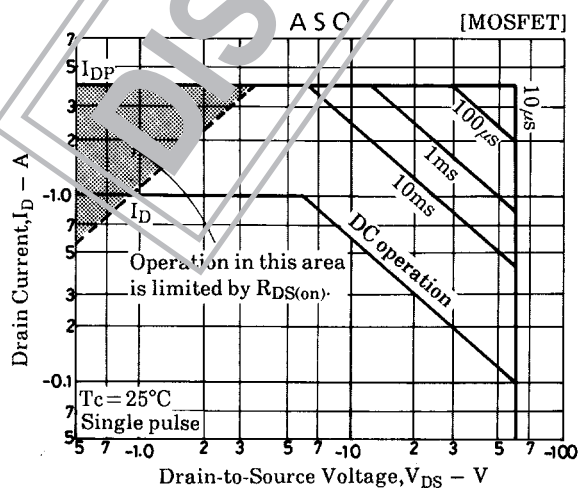
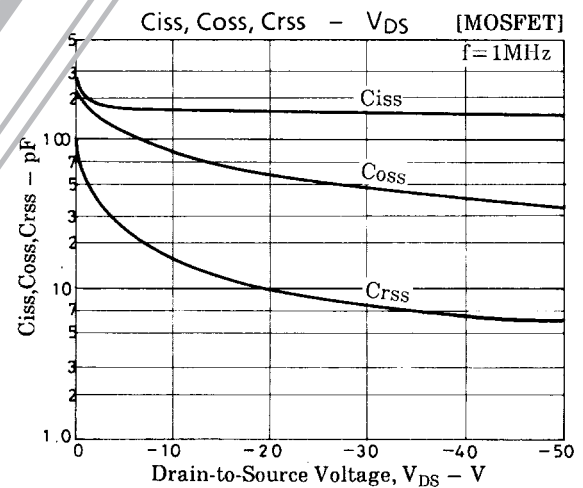
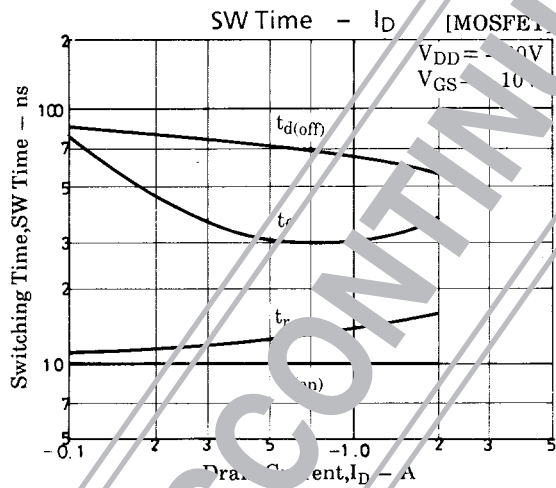
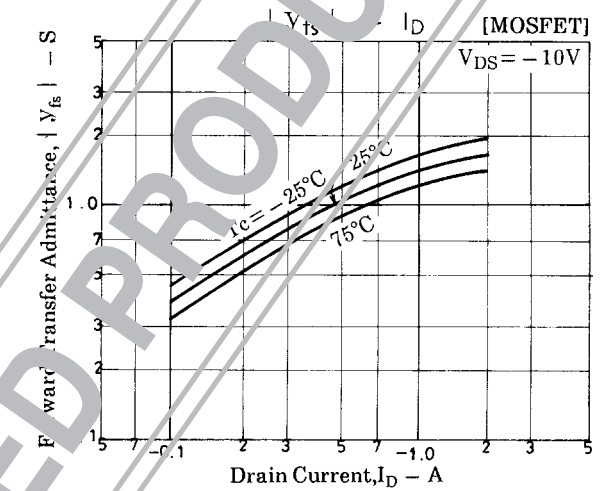
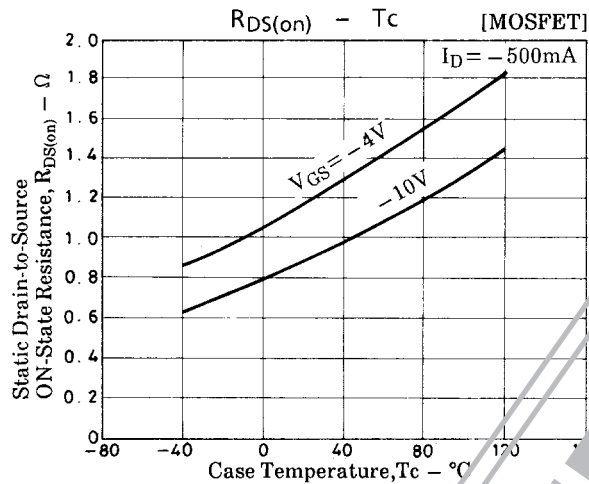
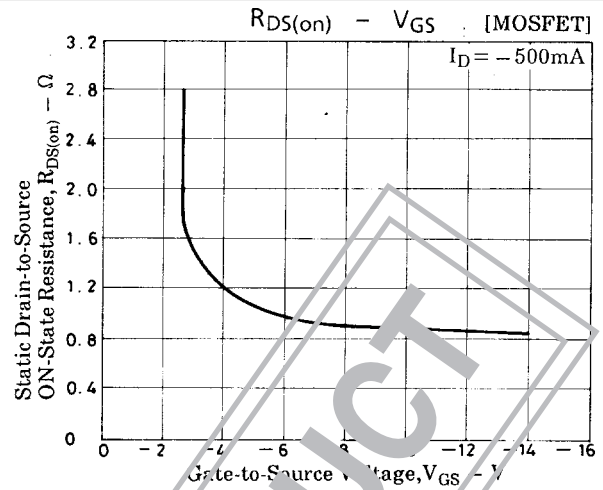
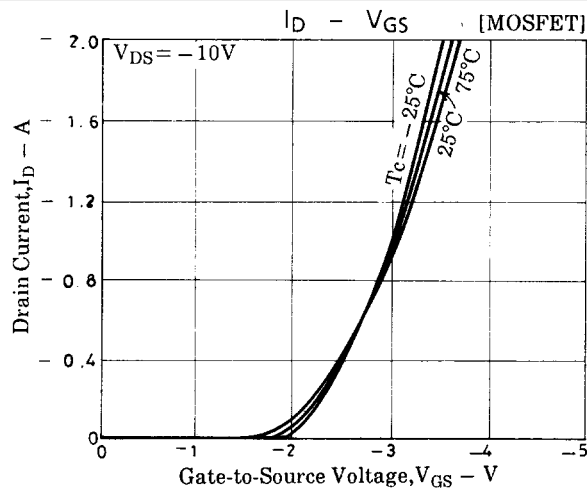
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
[MOSFET]						
D-S Breakdown Voltage	$V_{(BR)DSS}$	$I_D=-1\text{mA}$, $V_{GS}=0$	-60			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-60\text{V}$, $V_{GS}=0$			-100	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 12\text{V}$, $V_{DS}=0$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=-10\text{V}$, $I_D=-1\text{mA}$	-1.0		-2.0	V
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS}=-10\text{V}$, $I_D=-500\text{mA}$	0	1.0		S
Static Drain-to-Source ON-State Resistance	$R_{DS(on)}$	$I_D=-500\text{mA}$, $V_{GS}=-10\text{V}$		1.2	1.2	Ω
	$R_{DS(on)}$	$I_D=-500\text{mA}$, $V_{GS}=-4\text{V}$		1.2	1.6	Ω
Input Capacitance	C_{iss}	$V_{DS}=-20\text{V}$, $f=1\text{MHz}$		160		pF
Output Capacitance	C_{oss}	$V_{DS}=-20\text{V}$, $f=1\text{MHz}$		60		pF
Reverse Transfer Capacitance	C_{rss}	$V_{DS}=-20\text{V}$, $f=1\text{MHz}$		10		pF
Turn-ON Delay Time	$t_{d(on)}$	See specified Test Circuit		10		ns
Rise Time	t_r	See specified Test Circuit		13		ns
Turn-OFF Delay Time	$t_{d(off)}$	See specified Test Circuit		70		ns
Fall Time	t_f	See specified Test Circuit		30		ns
Diode Forward Voltage	V_{SD}	$I_S=-1\text{A}$, $V_{GS}=0$		-0.9		V
[SBD]						
Reverse Voltage	V_R	$I_R=200\mu\text{A}$	50			V
Forward Voltage	V_F	$I_F=500\text{mA}$			0.55	V
Reverse Current	I_R	$V_R=25\text{V}$			50	μA
Interterminal Capacitance	C	$V_R=10\text{V}$, $f=1\text{MHz}$ Cycle		18		pF
Reverse Recovery Time	t_{rr}	$I_F=I_R=100\text{mA}$, See specified Test Circuit			10	ns
Thermal Resistance	R_{thj-a}	Mounted on ceramic board (750mm ² ×0.8mm)		100		$^{\circ}\text{C/W}$

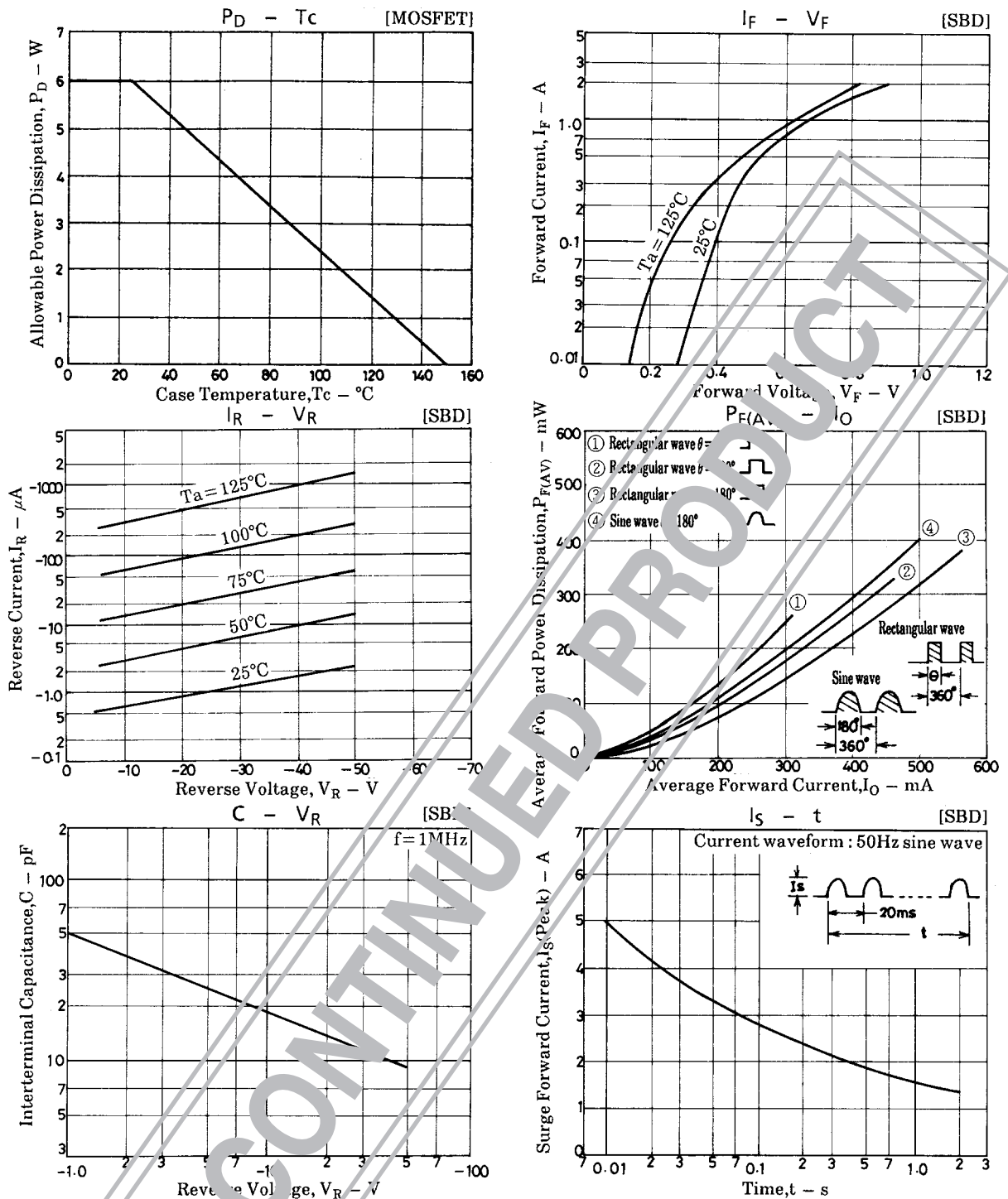
Switching Time Test Circuit [MOSFET]



Trr Test Circuit [SBD]







■ No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.

■ Anyone purchasing any products described or contained herein for an above-mentioned use shall:

- ① Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use;
- ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.

■ Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

This catalog provides information as of May, 1998. Specifications and information herein are subject to change without notice.